



FQB47P06 / FQI47P06

60V P-Channel MOSFET

General Description

These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as automotive, DC/DC converters, and high efficiency switching for power management in portable and battery operated products.

Features

- -47A, -60V, $R_{DS(on)} = 0.026\Omega$ @ $V_{GS} = -10 \text{ V}$
- Low gate charge (typical 84 nC)
- Low Crss (typical 320 pF)
- · Fast switching
- · 100% avalanche tested
- · Improved dv/dt capability
- · 175°C maximum junction temperature rating
- · RoHS Compliant



Absolute Maximum Ratings $T_C = 25$ °C unless otherwise noted

Symbol	Parameter		FQB47P06 / FQI47P06	Units
V_{DSS}	Drain-Source Voltage		-60	V
I _D	Drain Current - Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		-47	Α
			-33.2	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	-188	Α
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	820	mJ
I _{AR}	Avalanche Current	(Note 1)	-47	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	16	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-7.0	V/ns
P_{D}	Power Dissipation (T _A = 25°C) *		3.75	W
	Power Dissipation (T _C = 25°C)		160	W
	- Derate above 25°C		1.06	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.94	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

^{*} When mounted on the minimum pad size recommended (PCB Mount)

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60			V
ΔBV _{DSS} /ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = -250 μA, Referenced to 25°C		-0.06		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -60 V, V _{GS} = 0 V			-1	μΑ
		V _{DS} = -48 V, T _C = 150°C			-10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = -25 V, V _{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 25 V, V _{DS} = 0 V			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -23.5 A		0.021	0.026	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -30 V, I _D = -23.5 A (Note 4)		21		S
Dynam C _{iss}	ic Characteristics Input Capacitance	V - 25 V V - 0 V		2800	3600	рF
Coss	Output Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		1300	1700	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1.0 WH 12		320	420	pF
	ing Characteristics					
t _{d(on)}	Turn-On Delay Time			50	110	ns
t _r	Turn-On Rise Time	$V_{DD} = -30 \text{ V}, I_D = -23.5 \text{ A},$		450	910	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 25 \Omega$		100	210	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		195	400	ns
Q _g	Total Gate Charge	V _{DS} = -48 V, I _D = -47 A,		84	110	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		18		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		44		nC
Drain-S	Source Diode Characteristics a	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				-47	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				-188	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -47 A			-4.0	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = -47 A,		130		ns
		†aa.a.	——	1	 	

 dI_F / dt = 100 A/ μ s

(Note 4)

0.55

Q_{rr}

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 0.43mH, I_{AS} = -47A, V_{DD} = -25V, R_{G} = 25 Ω , Starting T_{J} = 25°C 3. I_{SD} ≤ -47A, di'dt ≤ 300 μ s, V_{DD} ≤ BV_{DSS}, Starting T_{J} = 25°C 4. Pulse Test : Pulse width ≤300 μ s, Duty cycle <2% 5. Essentially independent of operating temperature

Reverse Recovery Charge

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μС

Typical Characteristics

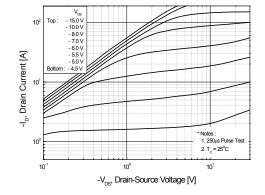


Figure 1. On-Region Characteristics

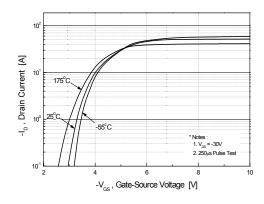


Figure 2. Transfer Characteristics

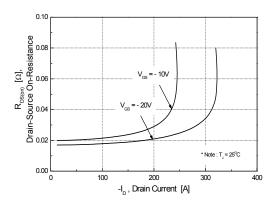


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

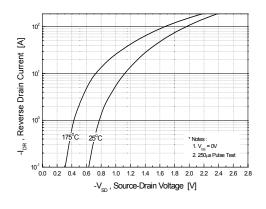


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

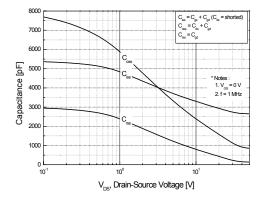


Figure 5. Capacitance Characteristics

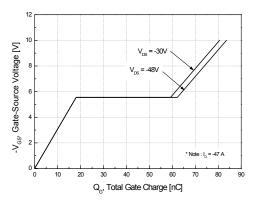


Figure 6. Gate Charge Characteristics

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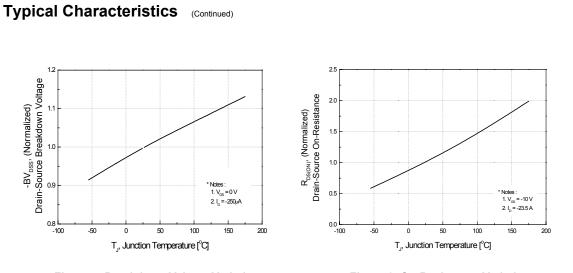


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature

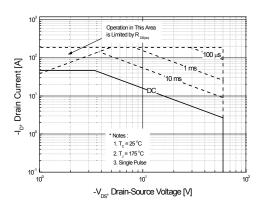


Figure 9. Maximum Safe Operating Area

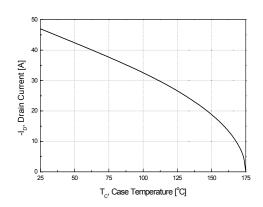


Figure 10. Maximum Drain Current vs. Case Temperature

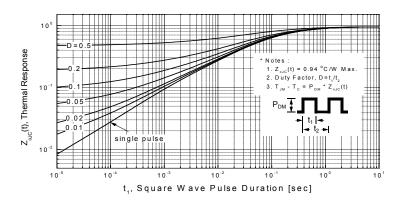
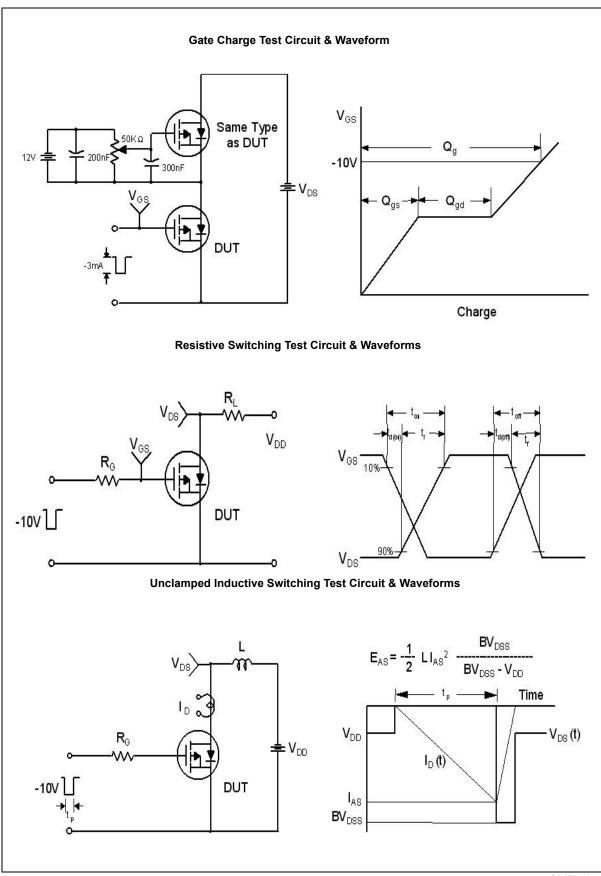
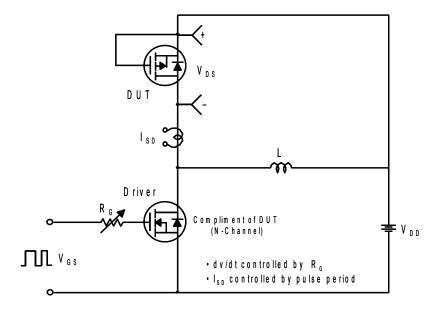


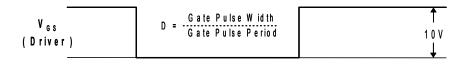
Figure 11. Transient Thermal Response Curve

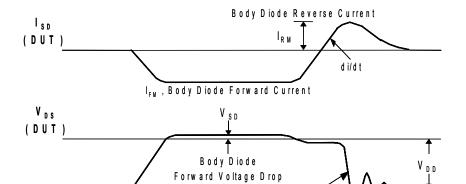
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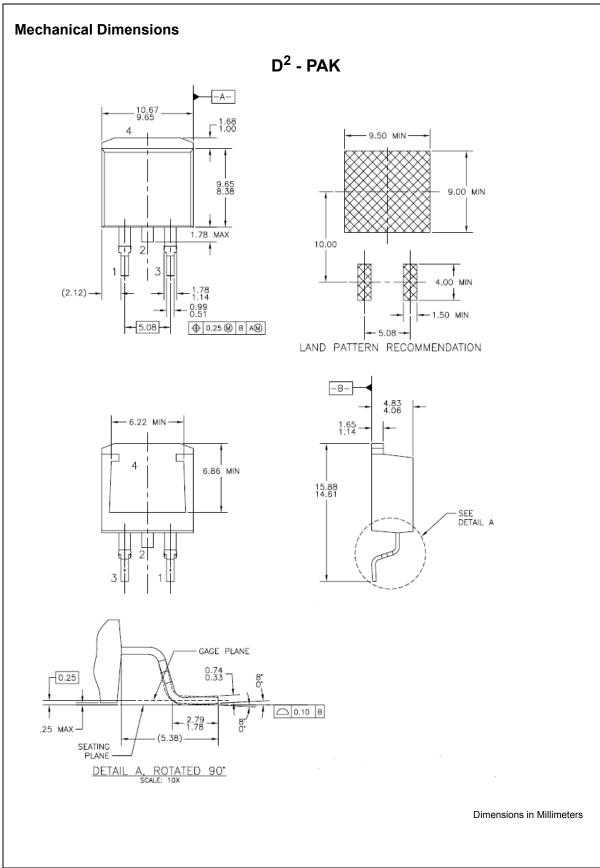
Peak Diode Recovery dv/dt Test Circuit & Waveforms





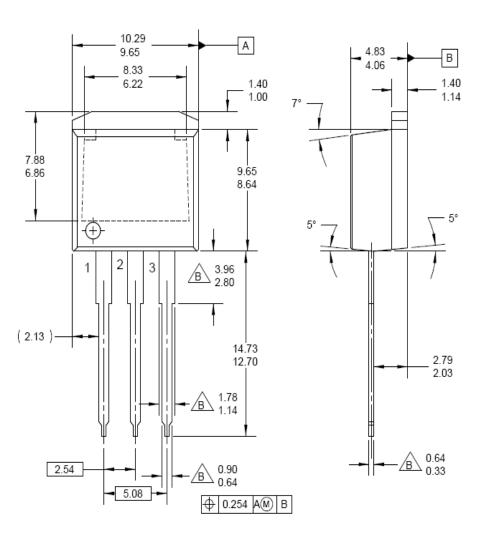


Body Diode Recovery dv/dt



Mechanical Dimensions

I² - PAK



Dimensions in Millimeters





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